



APTEK LABORATORIES, INC.

ISO 9001/ AS9100 Certified

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TECHNICAL DATA & INFORMATION

DIS-A-PASTE® 2000-A/B

Thermally conductive urethane adhesive

PRODUCT DESCRIPTION

DIS-A-PASTE 2000-A/B is a two component, mineral filled, electrically insulating soft urethane paste adhesive. It is designed to bond many dissimilar substrates and dissipate device generated heat. **DIS-A-PASTE 2000-A/B** is a 100% solids, solvent free system that will not form voids during cure or outgas after being fully cured.

DIS-A-PASTE 2000-A/B is a non-TDI based urethane system which has outstanding reversion resistance and physical stability when subjected to high heat and humidity environments. As a urethane, this system displays higher ionic purity than epoxy systems minimizing the chance of corrosion around sensitive components and circuitry.

KEY FEATURES AND BENEFITS

- Low modulus/high elongation for minimum stress to sensitive components and ceramic substrates
- Low Tg for excellent low temperature cycling and performance
- Excellent substrate adhesion; superior to silicones
- Exceeds NASA outgassing requirements for high vacuum environments
- Bonds DAT-A-THERM™ 1000 film to devices and substrates without loss of thermal conductivity
- Thixotropic version available for non-sag bonding and staking, designated as DIS-A-PASTE 2000T-A/B. Handle, mix and use the same way as DIS-A-PASTE 2000-A/B.
- Pre-measured kits available upon request. Easy to handle for small jobs and eliminates weighing.

HANDLING INFORMATION

Mix ratio, parts by weight: 100 (2000-A) / 5.5 (2000-B)

Work life, @ 25°C, 25 gm mass, mins. 40

Handling Notes:

1. Check for filler settlement in Part A with clean, dry, metal spatula. If necessary, remix slowly by hand until uniform. To minimize filler separation during storage, material can be refrigerated; however, still make sure to homogenize before use.
2. Prior to use, examine Part B bottle for crystallization or formation of an insoluble white precipitate which is a solid dimer of the liquid Part B. If no precipitate is noted, use as is. If precipitate is noted, it is not harmful; however, follow the instructions listed below for best results:

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DO NOT SHAKE PART B BOTTLE

- Place unopened Part B bottles into an air circulating oven at 45-60°C until clear amber to slightly hazy liquid is evident (white precipitate layer may also be present).
- Carefully remove bottles from oven without disturbing contents. If liquid contains gelled material - DO NOT USE! To use Part B, decant clear liquid out of bottle without disturbing the precipitate
- Excess Part B has been packaged to insure sufficient supply of liquid.
- Use entire bottle of Part B for each application if possible.
- Unused portion must be blanketed with dry nitrogen or argon and resealed to avoid moisture contamination.
- Store at 25°C; <50% RH

MIXING

Weigh 100 parts of DIS-A-PASTE 2000 Part A into a clean, dry, glass, metal, or plastic container and then add 5.5 parts of DIS-A-PASTE 2000 Part B. Machine mix on slow speed or hand stir with glass or metal stirrer until complete and thorough blending is achieved. Care should be taken to avoid any source of moisture contamination or air entrapment during mix.

CURE SCHEDULE

4 hours @ 100°C
or
8 hours @ 80°C
or
7 days @ RT

Notes:

1. For best results and a void free bond line, vacuum mixture at less than 10 mm Hg for 5-10 minutes after break.
2. As typical with urethane systems, a relaxation/stabilization period of 2-4 days at RT after heat cure is recommended before testing or service.

TYPICAL PROPERTIES

(values not to be used for specification purposes)

<u>CHARACTERISTICS</u>	<u>2000-A</u>	<u>2000-B</u>	<u>TEST METHOD</u>
Color	Off-white	Pale yellow to amber	Visual
Clarity	Opaque	Clear to hazy	Visual
Specific Gravity	2.07	1.24	ASTM D-1475
Viscosity @25°C, cps	115,000	45	ASTM D-1824
Flash point, °C	>200	>150	ASTM D-92
Shelf life @ 25°C, months factory sealed containers	6	6	

<u>CURED PHYSICAL PROPERTIES</u>	<u>DIS-A-PASTE 2000-A/B</u>	<u>TEST METHOD</u>
Hardness, Durometer A, 1/2" casting	83	ASTM D-2240
Lap shear, Al to Al, @25°C, psi	425	ASTM D-1002
Glass transition temp., °C	-60	ASTM E-831
Thermal coefficient of expansion, in/in/C	alpha 1 31 X 10 ⁻⁶ alpha 2 147 X 10 ⁻⁶	ASTM E-831 ASTM E-831
Thermal conductivity, W/mK	0.74	COMPARATIVE METHOD ASTM E-1225
Outgassing @ 10 ⁻⁶ Torr TML, % CVCM, %	0.15 0.004	ASTM E-595 ASTM E-595
Evidence of haze	None	ASTM E-595
<u>CURED ELECTRICAL PROPERTIES</u>	<u>DIS-A-PASTE 2000-A/B</u>	<u>TEST METHOD</u>
Volume resistivity @ 25°C, ohm-cm	7.0 x 10 ¹⁴	ASTM D-257
Dissipation factor (D) @25°C, KHz	0.03	ASTM D-150
Dielectric constant (K) @ 25°C, 1 KHz	5.8	ASTM D-150
Dielectric strength, 0.125" thick, Volts/mil	340	ASTM D-149

SAFETY AND FIRST AID

DIS-A-PASTE 2000-A is a mineral filled polyol resin that is safe to handle when used properly. It is judged to be low in toxicity and to be rated as a slight skin irritant. Avoid contact with skin and eyes and use in a well-ventilated area and avoid breathing vapors. In case of eye contact, flush with fresh clean water for at least 15 minutes; for skin contact, wash thoroughly with soap and water. If swallowed, drink at least one pint of water and call a physician. Refer to Material Safety Data Sheet for more details.

DIS-A-PASTE 2000-B is an organic isocyanate which may cause severe eye and skin irritation with direct contact. Inhalation of vapors may result in breathlessness, severe coughing, chest discomfort, and irritation of mucous membranes. Avoid skin and eye contact and use in a well-ventilated, hooded area. In case of eye contact, flush profusely with fresh clean water and contact a physician. For skin contact, wash thoroughly with soap and water. If inhaled, move subject to fresh air and provide water to drink. If swallowed, dilute with at least one pint of water and contact physician immediately. Refer to Material Safety Data Sheet for more details.

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